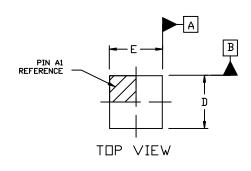


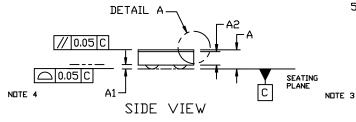


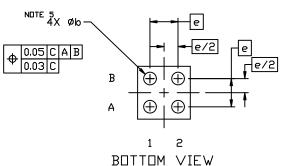
WLCSP4 0.75x0.75x0.3 CASE 567GG

CASE 567GG ISSUE A

DATE 19 JAN 2023







GENERIC MARKING DIAGRAM*



X = Specific Device Code

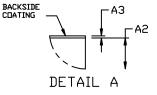
M = Month Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DATUM C, THE SEATING PLANE, IS DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- 4. COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- 5. DIMENSION 6 IS MEASURED AT THE MAXIMUM CONTACT BALL DIAMETER PARALLEL TO DATUM C.

	MILLIMETERS		
DIM	MIN.	N□M.	MAX.
Α			0.30
A1	0.04	0.06	0.08
A2	0.19 REF		
A3	0.025 REF		
b	0.16	0.18	0.20
D	0.73	0.75	0.78
E	0.73	0.75	0.78
е	0.40 BSC		



	PACKAGE DUTLINE
0.40	4X
PITCH	\$\phi \text{0.40} \\ \text{PITCH}

RECOMMENDED MOUNTING FOOTPRINT*

*FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRMYD.

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DESCRIPTION:	WLCSP4 0.75X0.75X0.3		PAGE 1 OF 1	

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